imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PS1101WA

Surface Mount Phototransistor/Flat Lenz Type

Features

Package	Flat Lenz Type, Water clear epoxy
Product features	 Outer Dimension 3.0 x 2.0 x 1.5mm (L x W x H) Photo Current : 3.5mA TYP. (V_{CE}=5V,Ee=5mW/cm²) Wide Distribution Lead-free soldering compatible RoHS compliant
Peak Sensitivity Wavelength	880nm
Half Intensity Angle	130 deg.
Die materials	Si
Rank grouping parameter	Sorted by photo current per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, and manual soldering XPlease refer to Soldering Conditions about soldering.
Taping and reel	2,500pcs per reel in a 8mm width tape. (Standard) Reel diameter:¢180mm
ESD	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

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(Ta=25°C)



Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Ratings	Unit
Collector Dissipation	Рс	75	mW
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Collector Voltage	V _{ECO}	5	V
Collector Current	lc	20	mA
Operating Temperature	T _{opr}	-30~+85	C
Storage Temperature	T _{stg}	-40~+90	C

Electro-Optical Characteristics

(Ta=25℃)

ltem		Symbol	Characteristics		Unit
nem	Conditions	Symbol			
Photo Current	V _{CE} =5V,	lc	Min.	0.7	mA
rioto Current	Ee=5mW/cm ² ^{×1}		TYP.	3.5	mA
Response Time	V _{CE} =10V, Ic=2mA, R _L =100Ω	tr/tf	ТҮР.	8/9	μs
Dark Current	V _{CEO} =10V	I _{CEO}	Max.	0.1	μA
Peak Sensitivity Wavelength	V _{CE} =5V	λр	TYP.	880	nm
Spatial Half Width	V _{CE} =5V	⊿θ	TYP.	130	deg.

%1 Color temperature is 2,856K. Employs a standard tungsten lamp.

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(Ta=25°C)



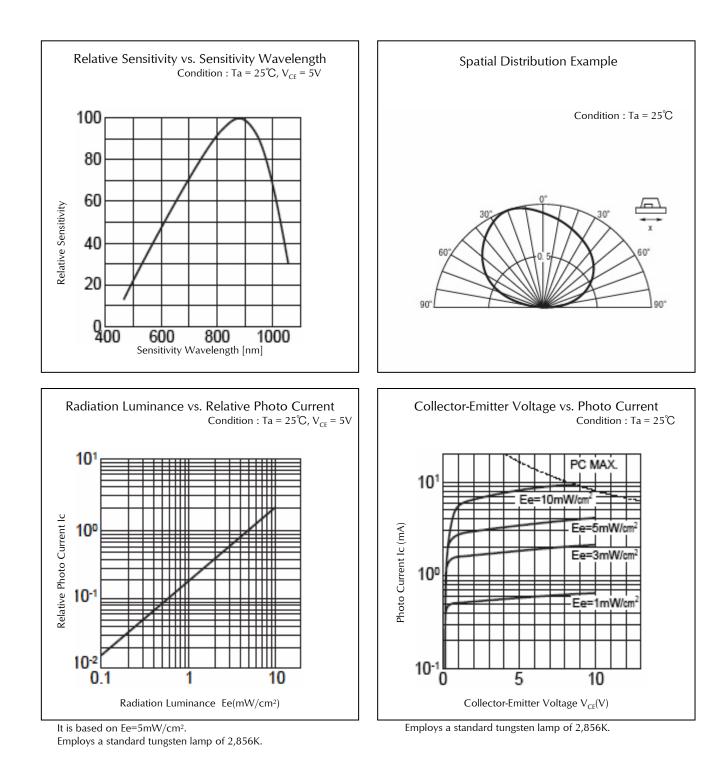
Rank	lc(r	Condition	
Kalik	MIN.	MAX.	Condition
А	0.7	1.4	
В	1.2	2.4	
С	2.1	4.2	$V_{CE} = 5V$ Ee = 5mW/cm ²
D	3.6	7.2	
E	6.3	12.6	

XPlease contact our sales staff concerning rank designation.





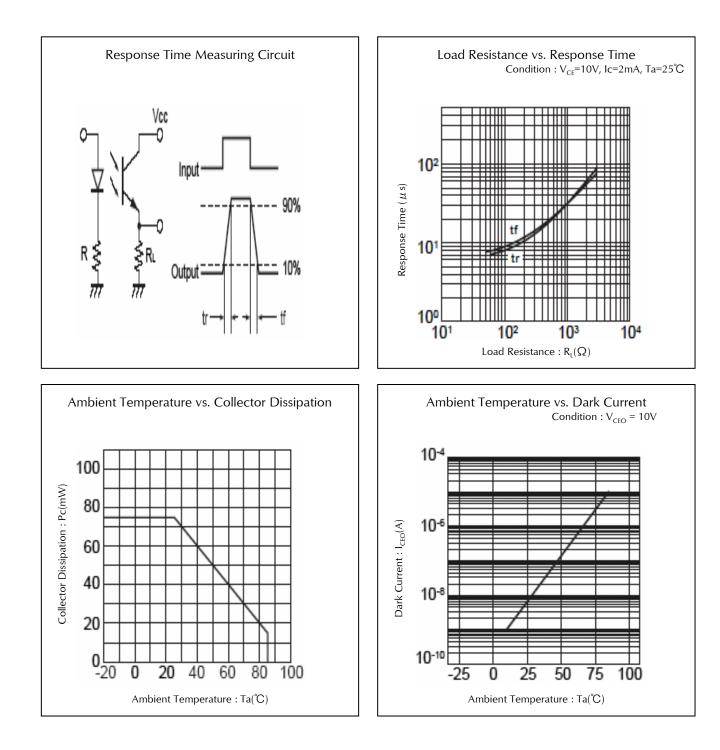
Technical Data







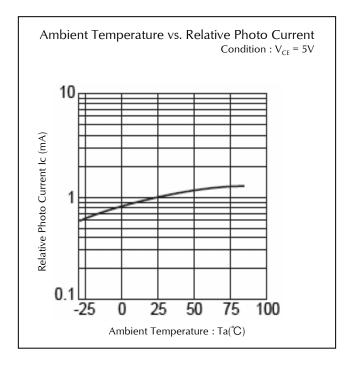
Technical Data







Technical Data



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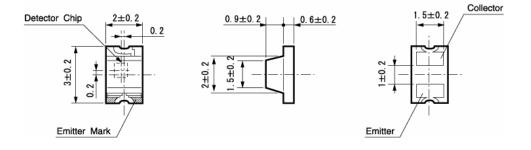




Package Dimensions

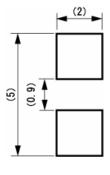
(Unit: mm)

Weight: (7.80)mg



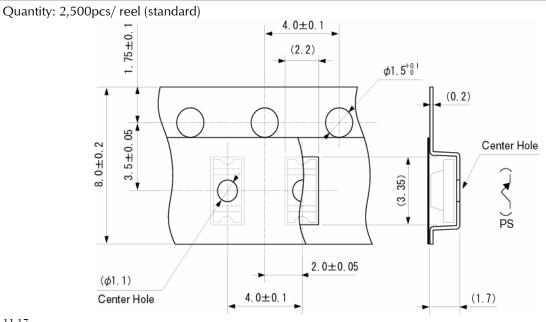
Recommended Soldering Pattern

(Unit: mm)



Taping Specification

(Unit: mm)



2004.11.17

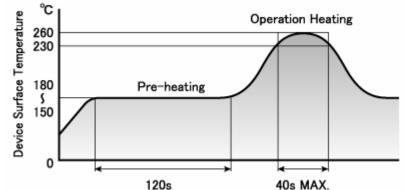
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Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the device resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the device from absorbing moisture.
- 3) Temperature fluctuation to the device during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350 ℃	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)



PS1101WA

Surface Mount Phototransistor/Flat Lenz Type



Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, Pc = Maxium Rated Power Dissipation	1 <i>,</i> 000 h	0/16
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°℃~180°C 120s Operating Heating 230°C Min. Peak temperature 260°℃	Twice	0/16
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/16
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60 \pm 2^{\circ}C$, RH = 90 $\pm 5\%$	1 <i>,</i> 000 h	0/16
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1 <i>,</i> 000 h	0/16
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1 <i>,</i> 000 h	0/16
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/16

Failure Criteria

ltems	Symbols	Conditions	Failure criteria
Photo Current	Ι _C	EE Value of each product Irradiance of Photo Current V _{CE} Value of each product Collector-emitter Voltage of Photo Current	Testing Max. Value ≧Initial Value x 1.3 Testing Min. Value ≦ Initial Value x 0.7
Dark Current	I _{CEO}	VCEO Value of each product Collector-emitter Voltage of Dark Current	Testing Max. Value ≧ Spec. Max. Value x 1.2



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